

#### **B-XT-1W Series**

#### 1W, FIXED INPUT, ISOLATED SINGLE OUTPUT SMD DC-DC CONVERTER



#### FEATURES

- ◆Footprint over pins 1.37cm²
- ◆Short Circuit Protection(automatic recovery)
- ◆I/O isolation voltage 1000VDC
- ◆Operating Temperature: -40°C ~ + 85°C
- ◆High efficiency up to 78%
- ◆Toroidal magnetics
- ◆Small SMD package with footprint
- ◆Power density 1.8W/cm³
- ◆Lead frame technology
- Multi-layer ceramic capacitors
- ◆Custom solutions available

#### **MODEL SELECTION B**<sup>0</sup>05<sup>0</sup>05<sup>0</sup>X<sup>0</sup>T<sup>0</sup>-1W<sup>0</sup>

- ①Product Series
- 2 Input Voltage
- 3 Output Voltage
- **4** Fixed Input
- ⑤SMD Package
- **®Rated Power**

#### **APPLICATIONS**

The B-XT-1W series are miniature, 1W DC/DC converters with high isolation in a SMD package. With a new package design these converters are qualified for the higher temperatures requested by lead-free reflow solder processes. With the small footprint, these converters are the ideal solution for board level power distribution, mainly for applications in the industrial and telecom field. For automated SMD production lines the devices can be supplied in standard tape and reel package.





SELECT	rion Gl	JIDE					
	Input		Oı	utput	Efficiency	Isolation	MTTF1
Order code	Voltage(VDC)	Current (mA)	Voltage	Current	(0/ T. )	Capacitance	MIIF
	Nominal	Rated Load	(VDC)	(mA)	(%.Typ.)	pF	KHrs
B0303XT-1W	3.3	410	3.3	303	81	29	5348
B0305XT-1W	3.3	390	5	200	83	30	3847
B0309XT-1W	3.3	400	9	111	74	34	3134
B0312XT-1W	3.3	400	12	83	76	40	3473
B0315XT-1W	3.3	400	15	66	81	42	2473
B0503XT-1W	5	270	3.3	303	85	31	5515
B0505XT-1W	5	294	5	200	83	33	6857
B0505NXT-1W	5	260	5	200	86	42	3933
B0506XT-1W	5	278	6	167	83	43	6677
B0509XT-1W	5	267	9	111	85	38	5501
B0512XT-1W	5	260	12	83	74	44	3957
B0515XT-1W	5	256	15	66	78	43	2747
B1205XT-1W	12	124	5	200	80	50	4683
B1209XT-1W	12	114	9	111	80	72	4008
B1212XT-1W	12	113	12	83	85	89	3121
B1215XT-1W	12	111	15	66	81	100	2316

1. Calculated using MIL-HDBK-217FN2 with nominal input voltage at full load.

All specifications typical at TA=25°C, nominal input voltage and rated output current unless otherwise specified.

Input Characteristics					
Parameter	Conditions	Min.	Тур.	Max.	Units
Voltage range	Continuous operation, 3.3V input	2.97	3.3	3.63	VDC
	Continuous operation, 5V input	4.5	5	5.5	VDC
	Continuous operation, 12V input	10.8	12	13.2	VDC
Start up time			30	47	mA p-p

Isolation Characteristics							
Parameter	Conditions	Min.	Тур.	Max.	Units		
Isolation voltage	Flash tested for 1 second	1000			VDC		
Resistance	Viso= 1000VDC	10			GΩ		

General Characteristics					
Parameter	Conditions	Min.	Тур.	Max.	Units
Switching frequency	All output types		110		kHz

Absolute Maximum Ratings	
Parameter	Conditions
Lead temperature 1.5mm from case for 10 seconds	300℃
Internal power dissipation	600mW
Input voltage V , B03 types	5.5V
Input voltage Vin, B05 types	7V
Input voltage Vin, B12 types	15V



#### **B-XT-1W Series**

<b>Output Specifica</b>	tions				
Parameter	Conditions	Тур.	Max.	Unit	
Rated Power	TA=-40°C to 85°C	0.1		1.0	W
Voltage Set Point	See tolerance envelope				
Line regulation	High VIN to low VIN		1.0	1.2	%%
	10% load to rated load, 0303& 0503		10	14	%
	10% load to rated load, 0505& 1205		12.8	15	%
Load regulation <sup>1</sup>	10% load to rated load, 0506		9.2	10	%
	10% load to rated load, 0509 & 1209		8.3	9.0	%
	10% load to rated load, 0512& 1212		6.8	7.5	%
	10% load to rated load, 0515& 1215		6.3	7.0	%
	BW=DC to 20MHz, 3.3V output types, 0305 & 0505		40	60	mV
	BW=DC to 20MHz, 3.3V output types,0505 & 1205		62	85	mV
Ripple & Noise	BW=DC to 20MHz, 0506		103	170	mV j
Trippie & Noise	BW=DC to 20MHz, 0509& 1209		49	75	mV
	BW=DC to 20MHz, 0512& 1212		39	65	mV
	BW=DC to 20MHz, 0515& 1215		38	76	mV j

Temperature Ch	aracteristics				
Parameter	Conditions	Min.	Тур.	Max.	Units
Specification	All output types	-40		85	°C
Storage		-55		125	$^{\circ}$
	0305, 0309, 0315		25		$^{\circ}$
Case temperature	0303, 0312, 0503, 0505, 0509, 0512C, 0515		30		°C
rise above ambient	0505, 1205		43		°C
	1209, 1212, 1215		40		$^{\circ}$
Cooling	Free air convection				

#### **Technical notes**

#### ISOLATION VOLTAGE

'Hi Pot Test'、'Flash Tested'、"Withstand Voltage ". Proof Voltage". 'Dielectric Withstand Voltage'&'Isolation Test Voltage" are all terms that relate to the same thing, a test voltage, applied for a specified time, across a component designed to provide electrical isolation, to verify the integrity of that isolation.

Professional Power Module B-XT-1W series of DC/DC converters are all 100% production tested at their stated isolation voltage. This is 1kVDC for 1 second.

A question commonly asked is, "What is the continuous voltage that can be applied across the part in normal operation?"

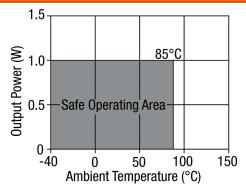
For a part holding no specific agency approvals, such as the B-XT-1W series, both input and output should normally be maintained within SELV limits i.e. less than 42.4V peak, or 60VDC. The isolation test voltage represents a measure of immunity to transient voltages and the part should never be used as an element of a safety isolation system. The part could be expected to function correctly with several hundred volts offset applied continuously across the isolation barrier; but then the circuitry on both sides of the barrier must be regarded as operating at an unsafe voltage and further isolation/insulation systems must form a barrier between these circuits and any user-accessible circuitry according to safety standard requirements.

#### REPEATED HIGH-VOLTAGE ISOLATION TESTING

It is well known that repeated high-voltage isolation testing of a barrier component can actually degrade isolation capability, to a lesser or greater degree depending on materials, construction and environment. The B-XT-1W series has toroidal isolation transformers, with no additional insulation between primary and secondary windings of enameled wire. While parts can be expected to withstand several times the stated test voltage, the isolation capability does depend on the wire insulation. Any material, including this enamel (typically polyurethane) is susceptible to eventual chemical degradation when subject to very high applied voltages thus implying that the number of tests should be strictly limited. We therefore strongly advise against repeated high voltage isolation testing, but if it is absolutely required, that the voltage be reduced by 20% from specified test voltage.

This consideration equally applies to agency recognized parts rated for better than functional isolation where the wire enamel insulation is always supplemented by a further insulation system of physical spacing or barriers.

### Temperature derating graph





#### **Application Notes**

#### Minimum load

The minimum load to meet datasheet specification is 10% of the full rated load across the specified input voltage range. Lower than 10% minimum loading will result in an increase in output voltage, which may rise to typically double the specified output voltage if the output load falls to less than 5%.

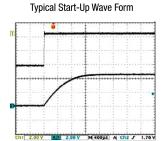
#### Capacitive loading and start up

Typical start up times for this series, with a typical input voltage rise time of 2.2  $\mu$  s and output capacitance of 10  $\mu$  F, are shown in the table below. The product series will start

into a capacitance of 47  $\mu$  F with an increased start time, however, the maximum recommended output capacitance is 10  $\mu$  F.

	Start-up time		
	μs		
B0303XT	437		
B0305XT	1359		
B0309XT	3435		
B0312XT	6590		
B0315XT	7625		
B0503XT	533		
B0505XT	1368		
B0505NXT	721		

	Start-up time		
	μS		
B0506XT	7200		
B0509XT	3146		
B0512XT	4960		
B0515XT	7740		
B1205XT	895		
B1209XT	2150		
B1212XT	3640		
B1215XT	7180		

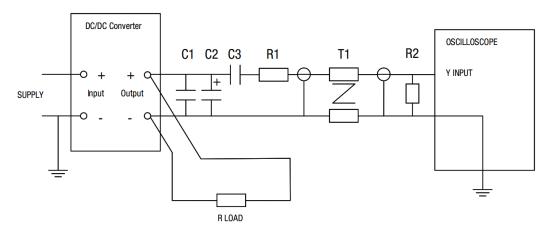


#### Ripple & Noise Characterization Method

Ripple and noise measurements are performed with the following test configuration.

C1	1 μ F X7R multilayer ceramic capacitor, voltage rating to be a minimum of 3 times the output voltage of the DC/DC converter				
C2	10 μ F tantalum capacitor, voltage rating to be a minimum of 1.5 times the output voltage of the DC/DC converter with an ESR of less				
	than 100m Ω at 100 kHz				
С3	100nF multilayer ceramic capacitor, general purpose				
R1	450 $\Omega$ resistor, carbon fi Im, $\pm 1\%$ tolerance				
R2	50 Ω BNC termination				
T1	3T of the coax cable through a ferrite toroid				
RLOAD	Resistive load to the maximum power rating of the DC/DC converter. Connections should be made via twisted wires				
Measured	Measured values are multiplied by 10 to obtain the specified values.				

#### **Differential Mode Noise Test Schematic**





#### **Application Notes**

#### **Output Ripple Reduction**

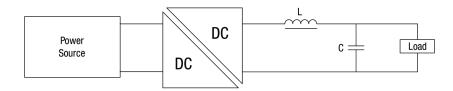
By using the values of inductance and capacitance stated, the output ripple at the rated load is lowered to 5mV p-p max.

#### **Component selection**

Capacitor: It is required that the ESR (Equivalent Series Resistance) should be as low as possible, ceramic types are recommended.

The voltage rating should be at least twice (except for 15V output), the rated output voltage of the DC/DC converter.

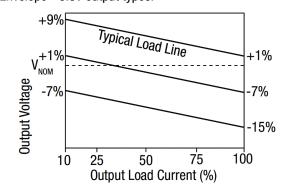
Inductor: The rated current of the inductor should not be less than that of the output of the DC/DC converter. At the rated current, the DC resistance of the inductor should be such that the voltage drop across the inductor is <2% of the rated voltage of the DC/DC converter. The SRF (Self Resonant Frequency) should be >20MHz.



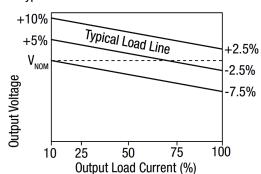
		Inductor		Capacitor
	L, µ H	SMD	Through Hole	C, μ F
B0303XT	10	82103C	11R103C	4.7
B0305XT	47	82473C	11R103C	4.7
B0309XT	22	82223C	11R223C	2.2
B0312XT	10	82103C	11R103C	1
B0315XT	47	82473C	11R473C	1
B0503XT	10	82103C	11R103C	4.7
B0505XT	47	82473C	11R473C	4.7
B0505NXT	47	82473C	11R473C	4.7
B0506XT	10	82103C	11R103C	4.7
B0509XT	22	82223C	11R223C	2.2
B0512XT	47	82473C	11R473C	1
B0515XT	47	82473C	11R473C	1
B1205XT	47	82473C	11R473C	4.7
B1209XT	22	82223C	11R223C	2.2
B1212XT	47	82473C	11R473C	1
B1215XT	47	82473C	11R473C	1

#### **Tolerance Envelopes**

Tolerance Envelope - 3.3V output types.



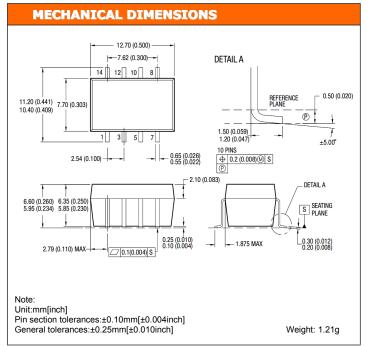
All other types.



The voltage tolerance envelope shows typical load regulation characteristics for this product series. The tolerance envelope is the maximum output voltage variation due to changes in output loading.



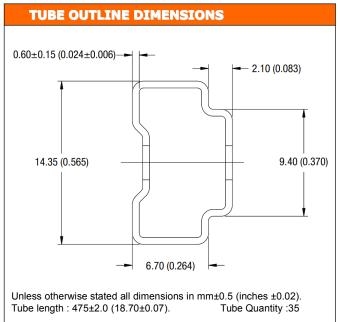
#### **OUTLINE DIMENSIONS & FOOTPRINT DETAILS**



SOLDER PAD DIMENSION
7.62 (0.3) 2.00 (0.079)
9.70 (0.382)
2.54 (0.1) - 1.00 (0.040) MIN
Dimensions in [mm], () = Inch Pin pitch tolerances: ±0.13 (±0.005) Other tolerances: ±0.25 (±0.01)

FOOTPRINT DETAILS	
Pin	Single
1	-Vin
3	+Vin
5	NA
7	-Vout
8	+Vout
10	NA
12	NA
14	NA

NA - Not available for electrical connection.



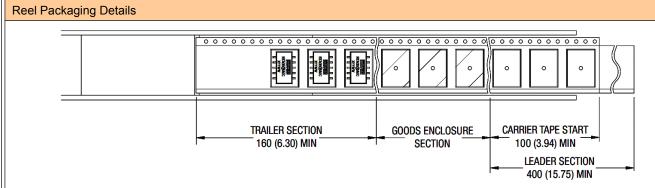
## Specifications can be changed any time without notice. No parallel connection or plug and play.

#### Note:

- 1. The load shouldn't be less than 10%, otherwise ripple will increase dramatically.
- 2. Operation under 10% load will not damage the converter; However, they may not meet all specification listed.
- 3. All specifications measured at Ta=25°C, humidity<75%, nominal input voltage and rated output load unless otherwise specified.
- 4. In this datasheet, all the test methods of indications are based on corporate standards.
- 5. Only typical models listed, other models may be different, please contact our technical person for more details.



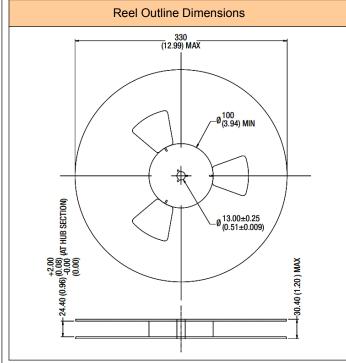
#### **Tape & Reel Specifications**

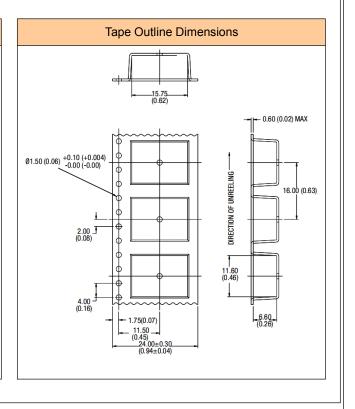


#### **Product Orientation**

Pin 1, located nearest to carrier drive sprocket.

Reel Quantity: 500





# Professional Power Module

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#### **RoHS COMPLIANT INFORMATION**

This series is compatible with RoHS soldering systems with a peak wave solder temperature of 300°C for 10 seconds. The pin termination finish on the SIP package type is Tin Plate, Hot Dipped over Matte Tin with Nickel Preplate. The DIP types are Matte Tin over Nickel Preplate. Both types in this series are backward compatible with Sn/Pb soldering systems.



#### REACH COMPLIANT INFORMATION

This series has proven that this product does not contain harmful chemicals, it also has harmful chemical substances through the registration, inspection and approval.